



# Center for Energy Efficient Electronics Science

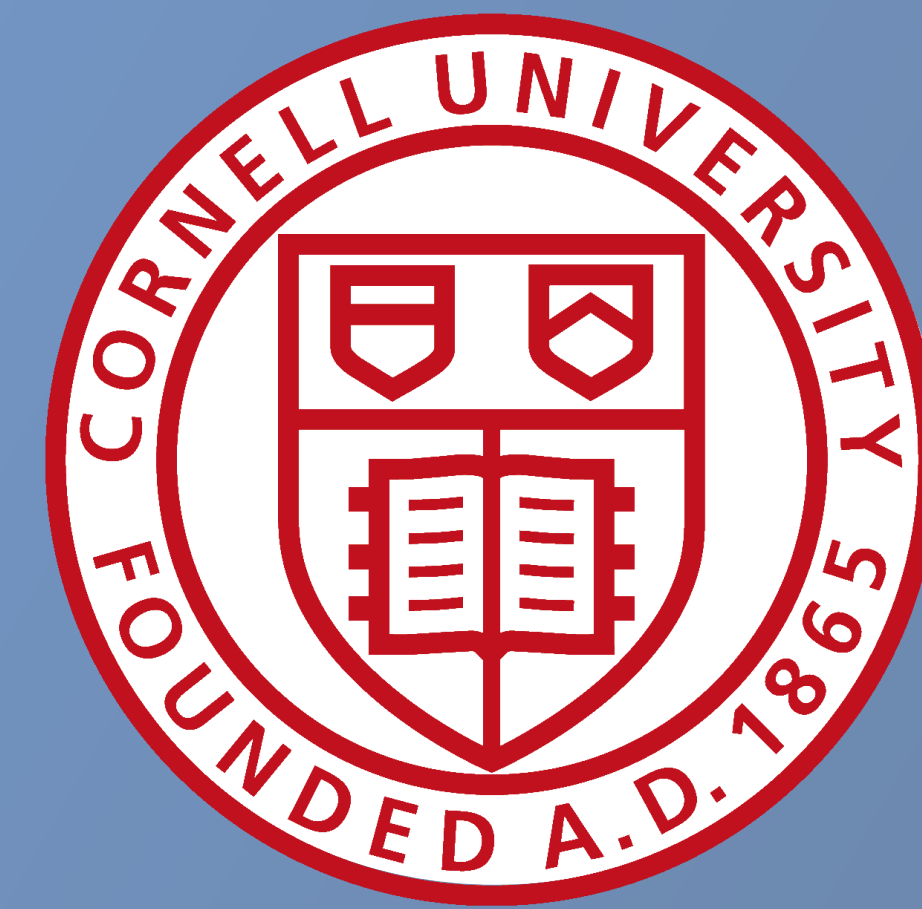
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## Spray Pyrolyzed Lanthanum-doped Zirconia for Thin Film Transistor Applications

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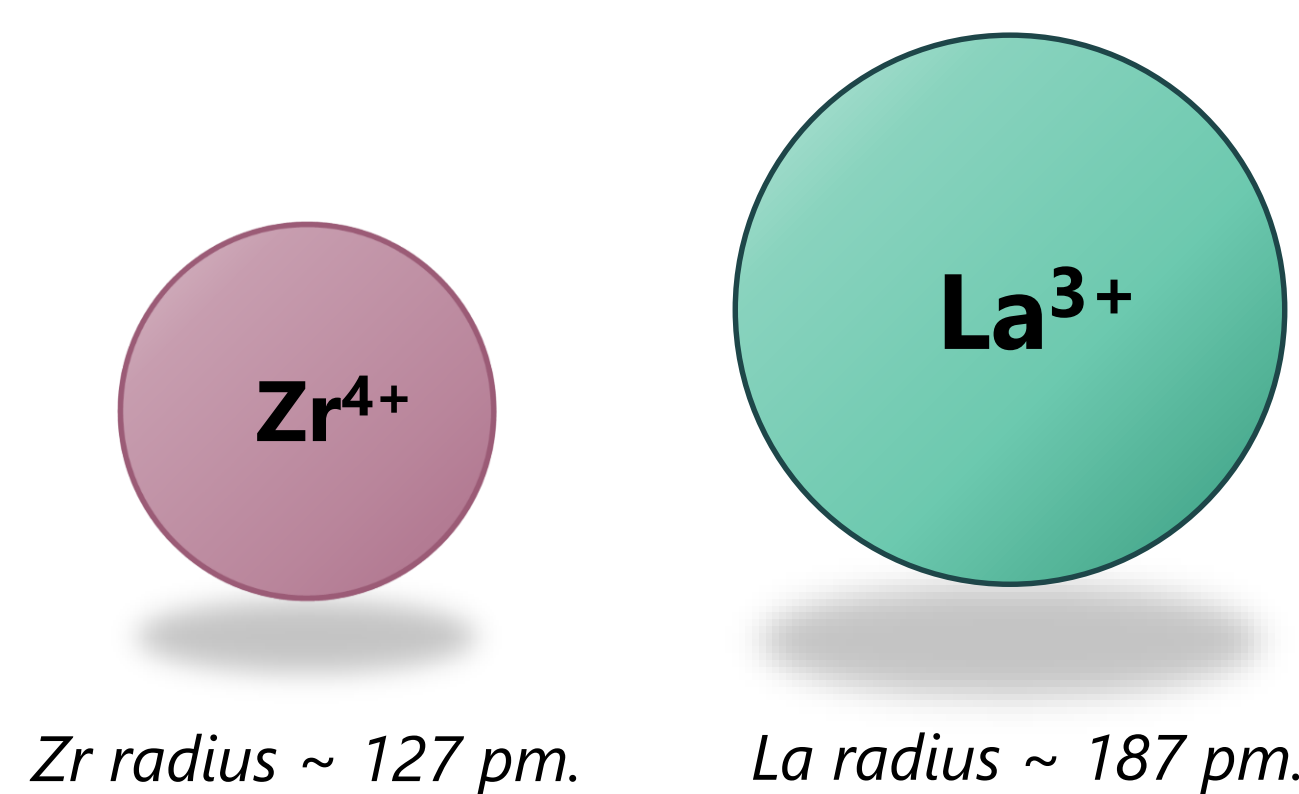
### Abstract

High- $\kappa$  metal oxides are being extensively investigated for use as viable gate dielectric materials to replace silicon dioxide ( $\text{SiO}_2$ ) in thin film transistors. Composite materials such as lanthanum-doped zirconia ( $\text{La}_x\text{Zr}_{1-x}\text{O}_y$ ) are attractive options to explore, as a combination of materials with individually favorable qualities can yield dielectrics with large bandgaps and high dielectric constants. Alloyed dielectrics, remaining amorphous at high temperatures, also tend to be more resistant to crystallization, which can potentially reduce leakage currents when used in fabricated devices. Lanthanum, which has a slightly larger atomic radius than zirconium, acts as a deterrent for crystallization in zirconia films by inducing steric hindrance effects during film formation. Lanthanum-doped zirconia (LZO) films with varying lanthanum concentrations of 0, 2, 5, 10, and 20% were grown using an alternative solution-processing technique, spray pyrolysis, as a means of investigating a versatile, highly repeatable manufacturing mechanism to replace traditional vacuum-based techniques. The resulting films have high dielectric constants ( $\sim 13$ - $14$ ), high breakdown fields ( $\sim 3$ - $4$  MV/cm), and leakage current densities as low as  $10^{-8}$  A/cm<sup>2</sup>. Finally, metal oxide thin-film transistors (TFTs) incorporating these dielectric films are fabricated and assessed for their electrical performance, as well as their potential for large-scale applications.

### Introduction and Background

$\text{ZrO}_2$  demonstrates characteristics that make it one of the most promising materials to replace  $\text{SiO}_2$ . Properties such as a high dielectric constant  $\kappa \sim 10$ - $23$ , a wide bandgap  $\sim 5.7$  eV, and high optical transparency are amongst the many qualities that make  $\text{ZrO}_2$  an attractive candidate as a gate dielectric for thin-film transistors (TFTs) [1].

Additionally, it is desirable for the dielectric film to be relatively smooth and uniform to achieve a homogeneous electric field distribution as well as a better dielectric-semiconductor interface to minimize interfacial defects [2, 3]. Amorphous films lack grain boundaries which induce higher leakage current [2].



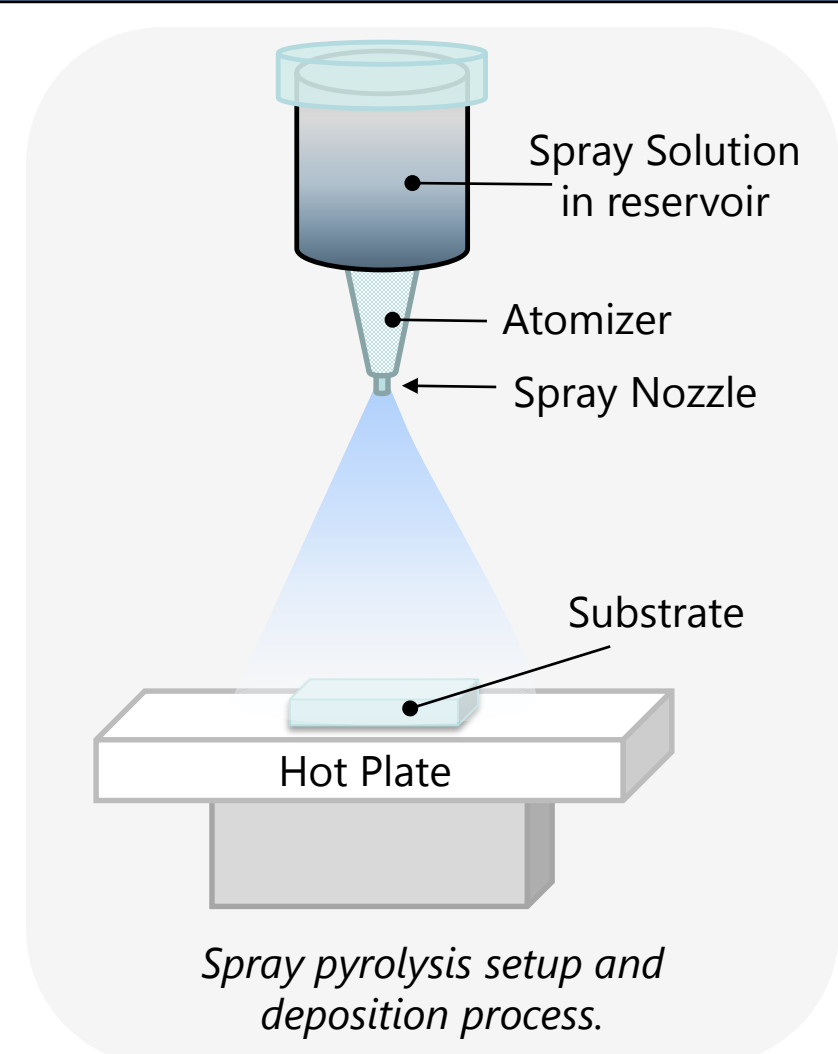
A viable option for impeding crystallization in zirconium oxide is to alloy it with aliovalent La, which may reduce oxygen vacancies, an important defect in high- $\kappa$  dielectrics. Alloying and lower deposition temperatures preserve the amorphous nature of the resulting films [2].

### Methods/Experimental Process

#### MIM Devices for LZO Characterization

Spray LZO Dielectric

Thermally evaporate Au contacts



#### TFT Devices using LZO Dielectrics

Spray LZO Dielectric

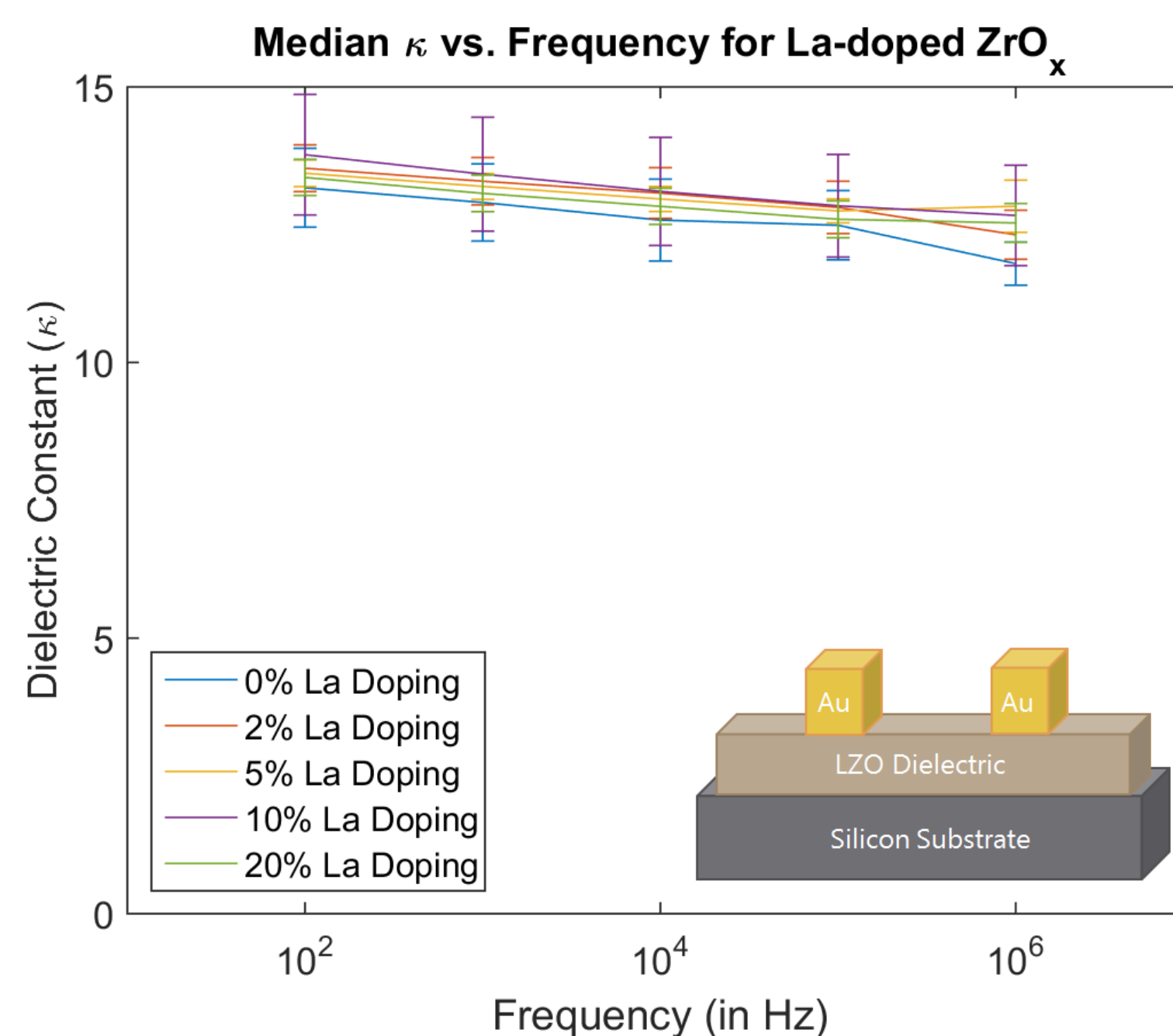
Spin-coat PMMA

Anneal ATO contacts

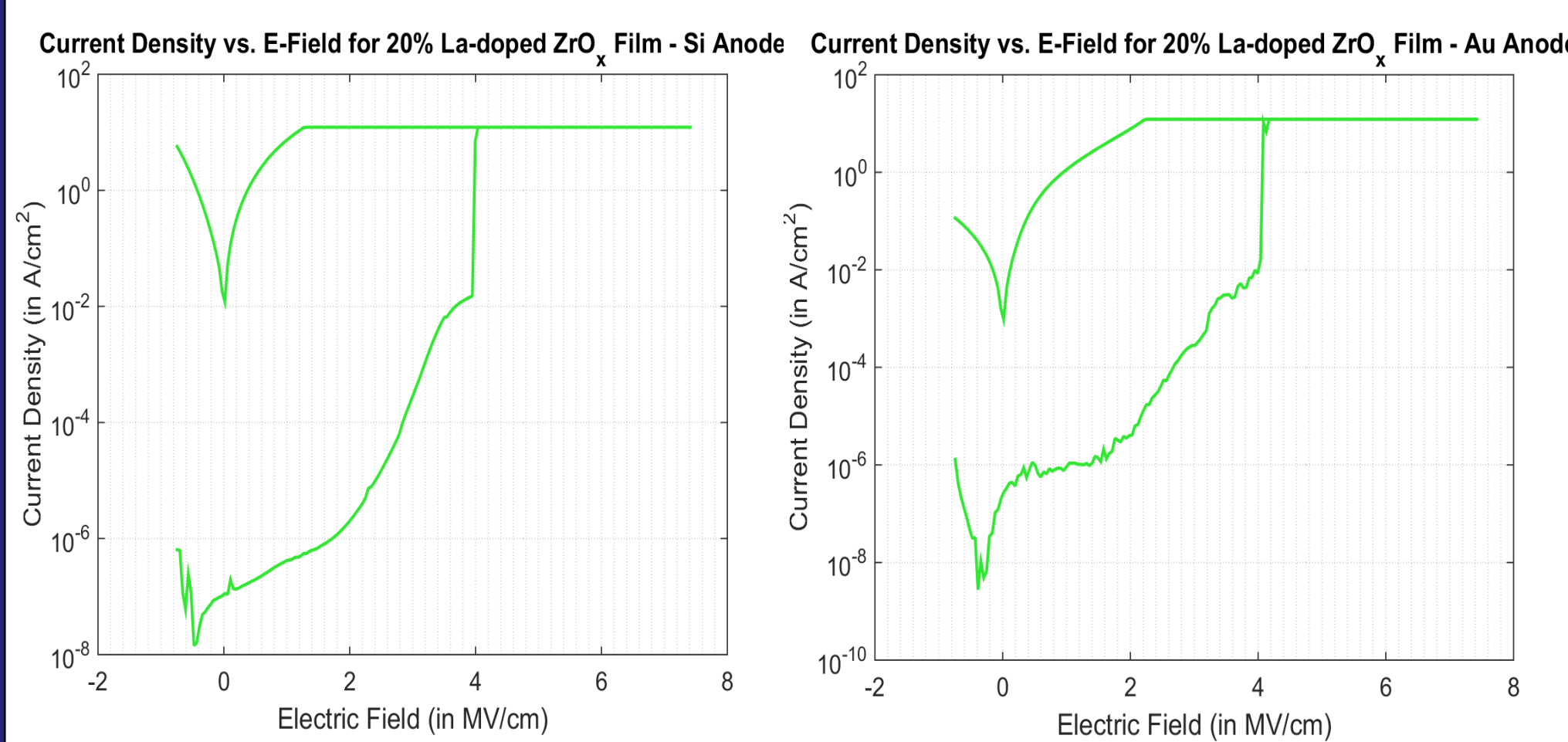
Inkjet Print ATO

Spray  $\text{SnO}_2$  Semiconducting Channel

### Results and Discussion



As little as 2% lanthanum doping can mitigate dielectric relaxation in pure zirconia. Lanthanum may stabilize the dielectric constant of zirconia, showing evidence of improving it at high frequencies ( $\sim 1$  MHz) for higher doping. Pure  $\text{ZrO}_x$  and  $\text{LaO}_x$  films have dielectric constants in the range of 10 – 20. The addition of  $\text{LaO}_x$  does not significantly alter the dielectric constant of the alloy films.

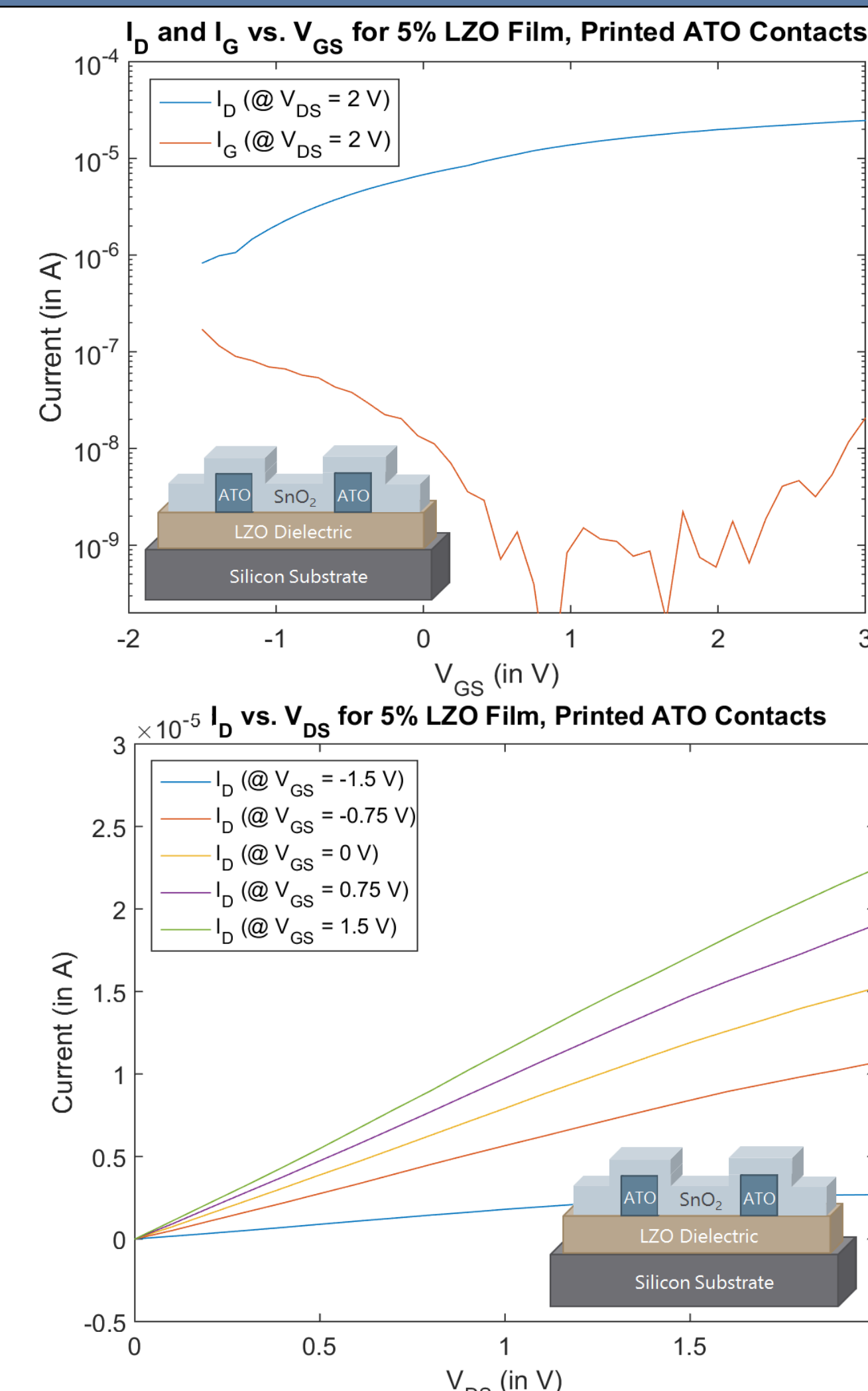


The resulting LZO films (for all lanthanum doping percentages) have thicknesses of 13-16 nm, breakdown fields of 3 – 4.5 MV/cm with evidence of the Fowler-Nordheim effect, and leakage currents of  $10^{-8}$  –  $10^{-6}$  A/cm<sup>2</sup>. These values are competitive for dielectric films deposited by spray pyrolysis and are a testament to the yield for high-quality electronic films by this technique.

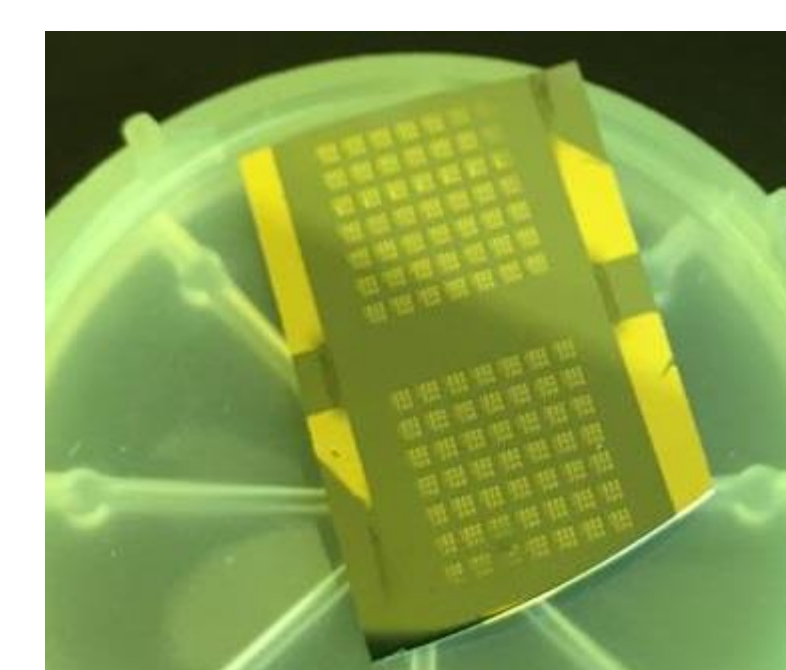
### Conclusions and Future Work

The primary purpose of this summer project is to characterize the dielectric properties, both from an electrical and materials perspective, of a specific spray pyrolyzed high- $\kappa$  dielectric: lanthanum-doped zirconia (LZO). Thin-film transistors incorporating LZO were made successfully, but the process by which TFTs are made using this particular dielectric material will benefit from further refining. The characterization of LZO will provide critical groundwork for future experimentation in TFT fabrication.

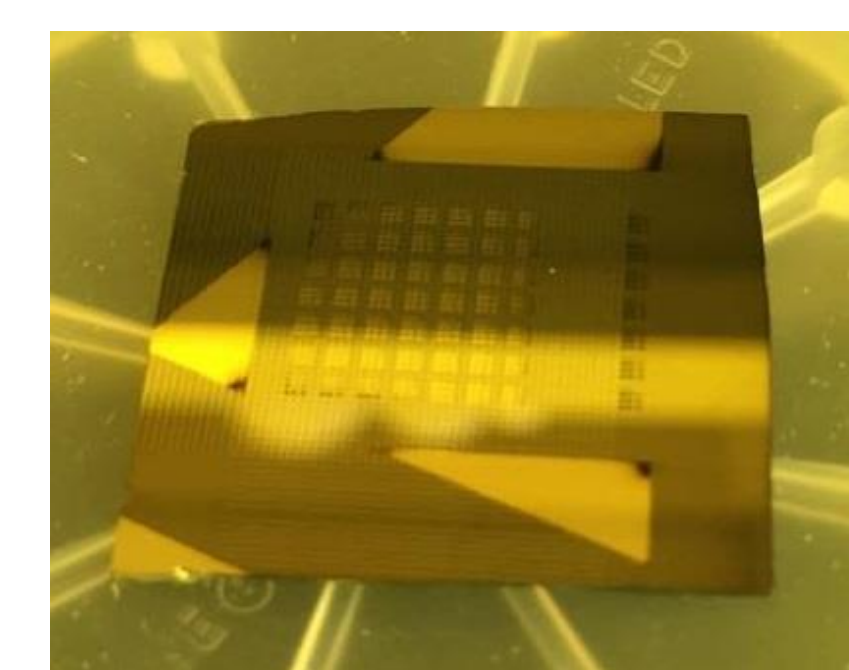
### TFT Characteristics



### MIM/TFT Devices



MIM structures with LZO film and thermally evaporated gold contacts



TFT devices with LZO film, zinc oxide semiconductor and thermally evaporated aluminum contacts

### Acknowledgements

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### References

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